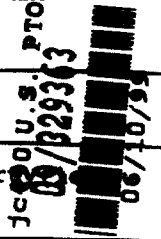


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IOS-51



To Honorable Commissioner of Patents and Trademarks  
Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):  
Satoru Shioya  
Akinobu Hira  
Hidehiro Sasaki  
Hisao Tokoro

Additional name(s) & addresses attached?  Yes  No

3. Nature of Conveyance:  
 Assignment  Merger  
 Security Agreement  Change of Name  
 Other \_\_\_\_\_

Execution Date May 19, 1999

2. Name and address of receiving party:  
Name: JSP Corporation

Internal Address: \_\_\_\_\_

Street Address: 1-1, Uchisaiwai-cho, 2-Chome  
Chiyoda-ku, Tokyo 100-8580 Japan

City: \_\_\_\_\_ State: \_\_\_\_\_

ZIP: \_\_\_\_\_

Additional name(s) & addresses attached?  Yes  No

4. Application number(s) or patent number(s):  
If this document is being filed together with a new application,  
the execution date of the application is: May 19, 1999

A. Patent Application No.(s) 09/329363

B. Patent No.(s) \_\_\_\_\_

06/23/1999 SBAVIS 00000002 09329363  
01 FC:581 40.00 OP

Additional numbers attached?  Yes  No

5. Name and address of party to whom correspondence concerning document  
should be mailed:  
Name: SHERMAN & SHALLOWAY

Internal Address: \_\_\_\_\_

Street Address: 413 North Washington Street

City: Alexandria State: VA ZIP: 22314

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).... \$ 40.00  
 Enclosed  
 Authorized to charge to deposit account

8. Deposit account number: 19-1980  
(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and Signature.  
*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Leonard W. Sherman \_\_\_\_\_ June 10, 1999

Name of Person Signing \_\_\_\_\_ Signature \_\_\_\_\_ Date \_\_\_\_\_

Total number of pages including cover sheet, attachments, and document: 2

Mail documents to be recorded with required cover sheet information to:  
Commissioner of Patents & Trademarks,  
Box Assignments  
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A S S I G N M E N T

WHEREAS, We, Satoru SHIOYA, Akinobu HIRA, Hidehiro SASAKI, Hisao TOKORO, residing respectively at 1884-3, Ooaza Takou, Kaminokawa-machi, Kawachi-gun, Tochigi 329-0524, Japan; Kasa-ai 202, 1078-4, Komanyu-machi, Utsunomiya-shi, Tochigi 320-0065, Japan; 36-5, Ooaza Yuukigaoka, Kaminokawa-machi, Kawachi-gun, Tochigi 329-0528, Japan; Buranshuru Togami 103, 282-1, Togami-cho, Utsunomiya-shi, Tochigi 320-0856, Japan; (hereinafter referred to as Inventors), have invented certain new and useful improvements in MOLDED ARTICLE OF FOAMED AND EXPANDED BEADS OF PROPYLENE RESIN; for which an application for United States Letters Patent was filed in the United States on N/A and assigned Serial Number N/A.

WHEREAS, JSP CORPORATION, a corporation of Japan, having a place of business at 1-1, Uchisaiwai-cho 2-chome, Chiyoda-ku, Tokyo 100-8580, Japan (hereinafter referred to as Company), is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefor in the United States and in any and all foreign countries.

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to us in hand paid, the receipt whereof is hereby acknowledged, and other valuable considerations, the said Inventors have sold, assigned and transferred, and by the presents do sell, assign and transfer unto said Company, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries and the entire right, title and interest in and to any and all Letters Patent, which may be granted thereof in the United States and its territorial possessions and in any and all foreign countries and in and to any and all divisions, reissues, continuations and extensions thereof.

We hereby authorize and request the Patent Office Officials in the United States and in any and all foreign countries to issue any and all of said Letters Patent, when granted, to said Company as the assignee of the entire right, title and interest in and to the same, for the sole use and behoof of the said Company, its successors and assigns.

FURTHER, We agree that we will communicate to said Company or its representatives any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, substitution, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said Company, make all rightful oaths and generally do everything possible to aid said Company, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and in any and all foreign countries.

IN TESTIMONY WHEREOF, We have hereunto set our hands this 19th day of May, 1999.

Signed in the presence of:

Witness: Atsuo Shimizu  
Atsuo Shimizu

Signed: Satoru Shioya  
Satoru Shioya

Witness: Atsuo Shimizu  
Atsuo Shimizu

Signed: Akinobu Hira  
Akinobu Hira

Witness: Atsuo Shimizu  
Atsuo Shimizu

Signed: Hidehiro Sasaki  
Hidehiro Sasaki

Witness: Atsuo Shimizu  
Atsuo Shimizu

Signed: Hisao Tokoro  
Hisao Tokoro